

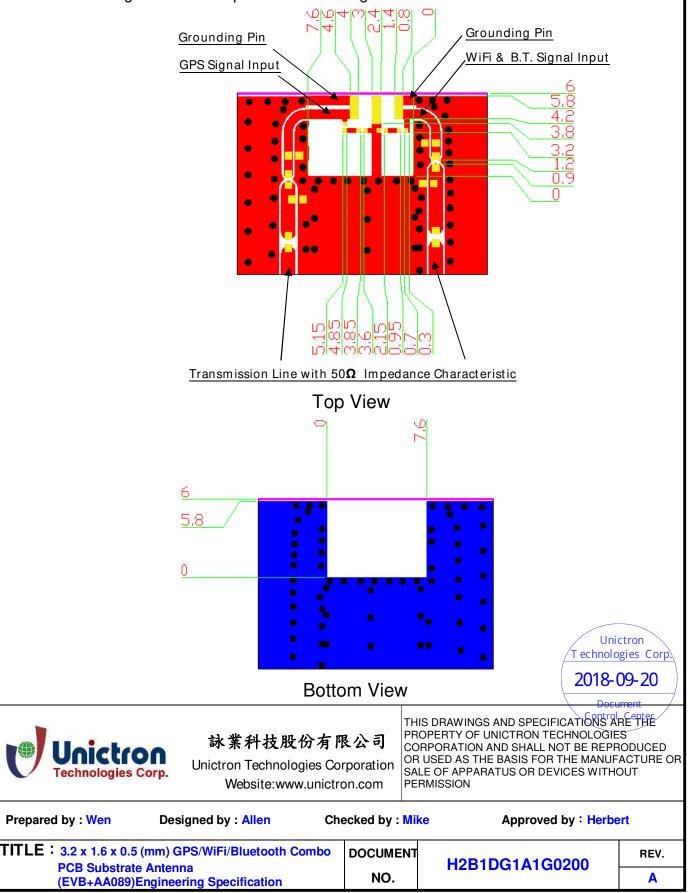
PAGE 1

5. Application for individual signal mode

5-1. Layout Guide (Unit : mm)

Solder Land Pattern:

The solder land pattern (gold marking areas) is shown below. Recommendation on matching circuit will be provided according to customer's installation conditions.



OF

14

5-2. Electrical Specifications (Evaluation Board Dimensions: 80 x 40 mm²) 5-2-1. Electrical Table (GPS Band)

Charact	eristics	Specifications	Unit
Outline Dimensions	6	3.2 x 1.6 x 0.5	mm
Ground Plane Dime	ensions	80 x 40	mm
Working Frequency	/	1575.42	MHz
Isolation(S ₂₁)		\leq -20 (typical)	dB
VSWR (@ center fr	requency)*	2 Max.	
Characteristic Impe	dance	50	Ω
Polarization		Linear Polarization	
Peak Gain	(@1575.40 MH-)	1.3 (typical)**	dBi
Efficiency	(@1575.42 MHz)	61 (typical)**	%

*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board. **A Typical value is for reference only, not guaranteed.

5-2-2. Electrical Table (WiFi & B.T. Band)

Charact	eristics	Specifications	Unit
Working Frequency	,	2400~2500	MHz
Isolation(S ₂₁)		\leq -16 (typical)	dB
VSWR (@ center fr	equency)*	2 Max.	
Characteristic Impe	dance	50	Ω
Polarization		Linear Polarization	
Peak Gain		1.8 (typical)**	dBi
Efficiency	(@2442 MHz)	68 (typical)**	%

*Center frequency means the frequency with the lowest value in return loss of the chip antenna on the evaluation board. **A Typical value is for reference only, not guaranteed.



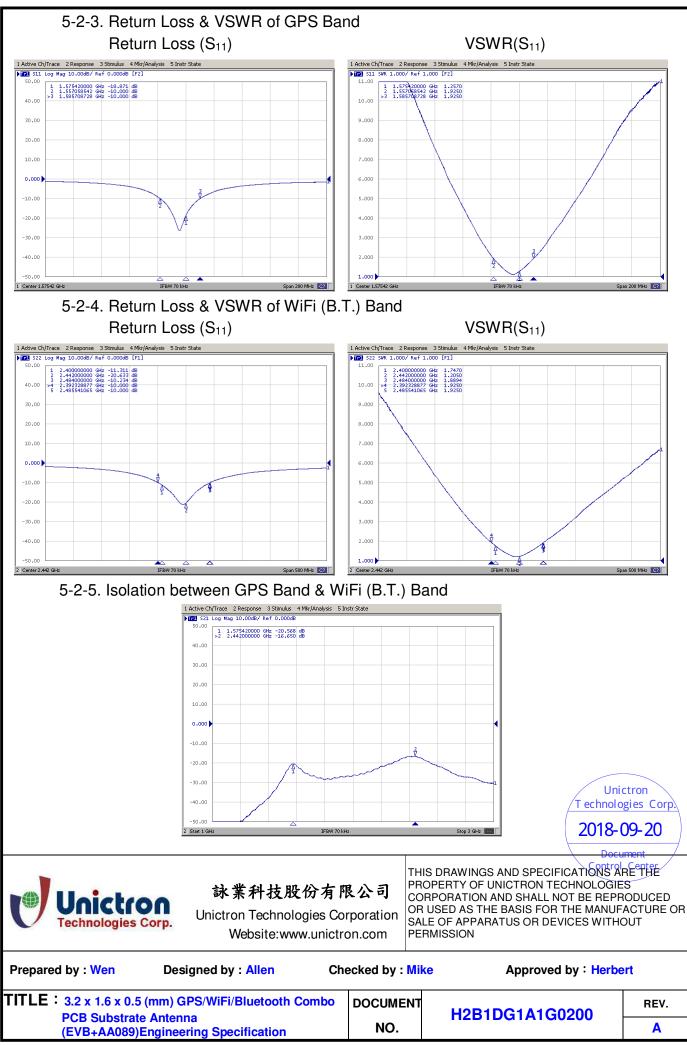
詠業科技股份有限公司

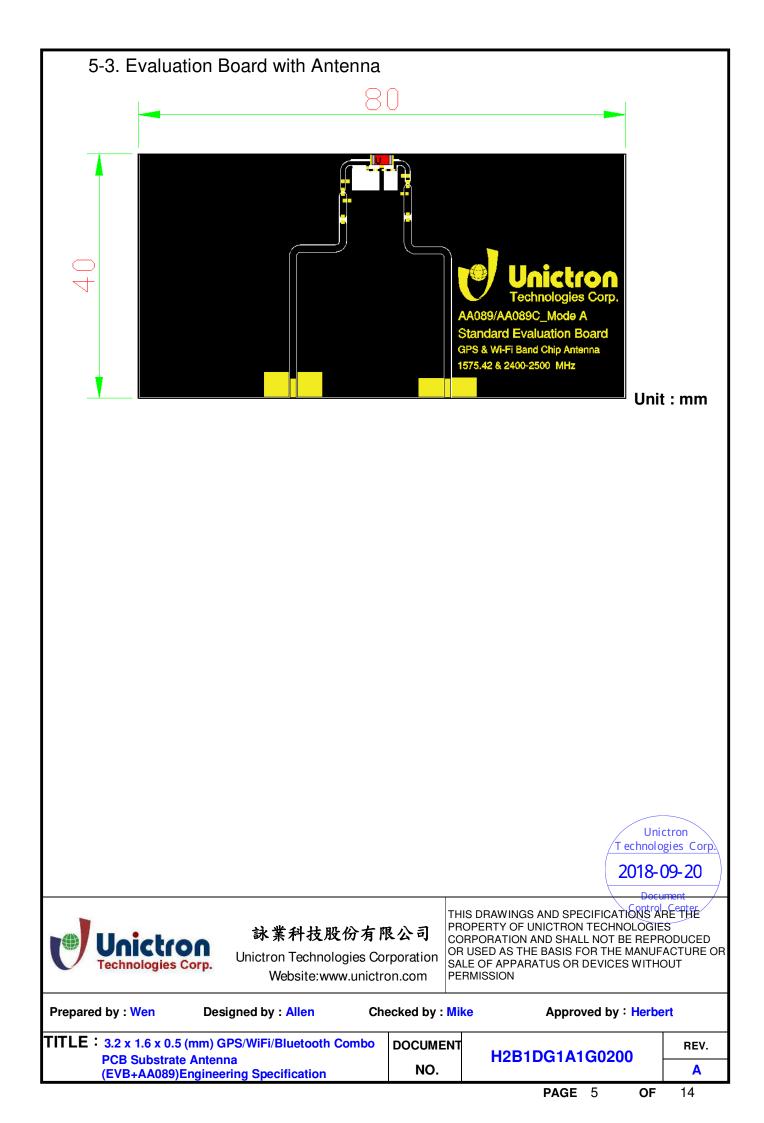
Unictron Technologies Corporation Website:www.unictron.com

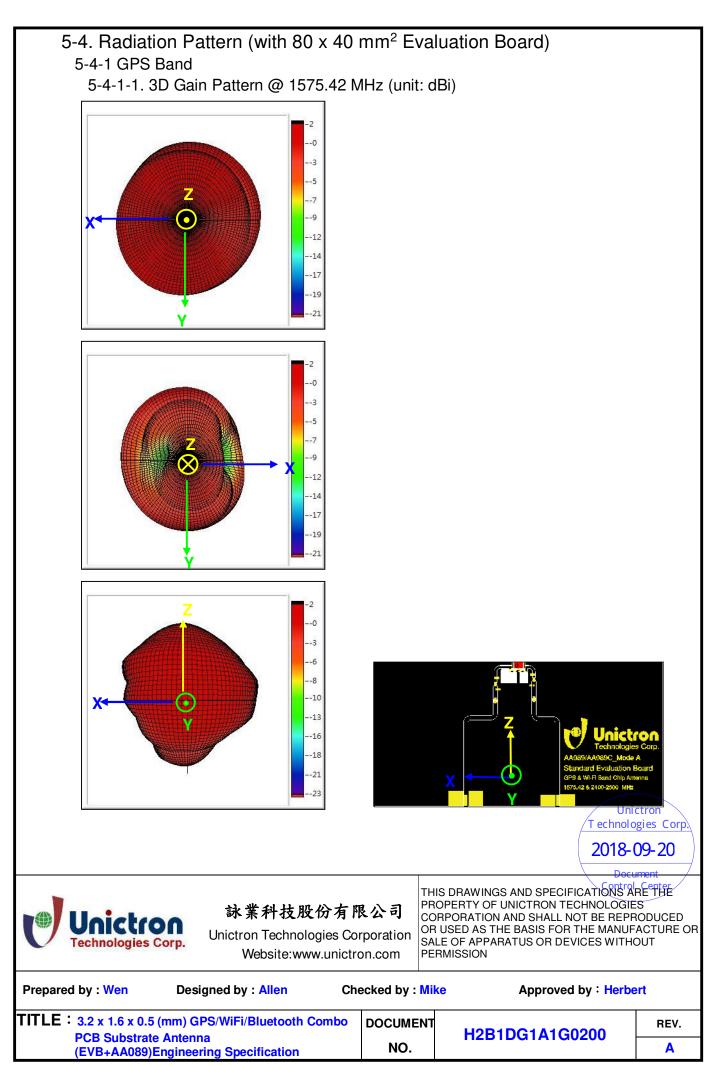
THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Unictron Technologies Corp. 2018-09-20

Prepared by : Wen	Designed by : Allen	Che	ecked by : Mil	ke	Appro	ved by	y: Herbe	ert
TITLE : 3.2 x 1.6 x 0.5	mbo	DOCUMENT	H2B	H2B1DG1A1G0200				
PCB Substrate (EVB+AA089)	e Antenna Engineering Specification		NO.	1120	HZDIDGIAIG0200			
					PAGE	3	OF	14



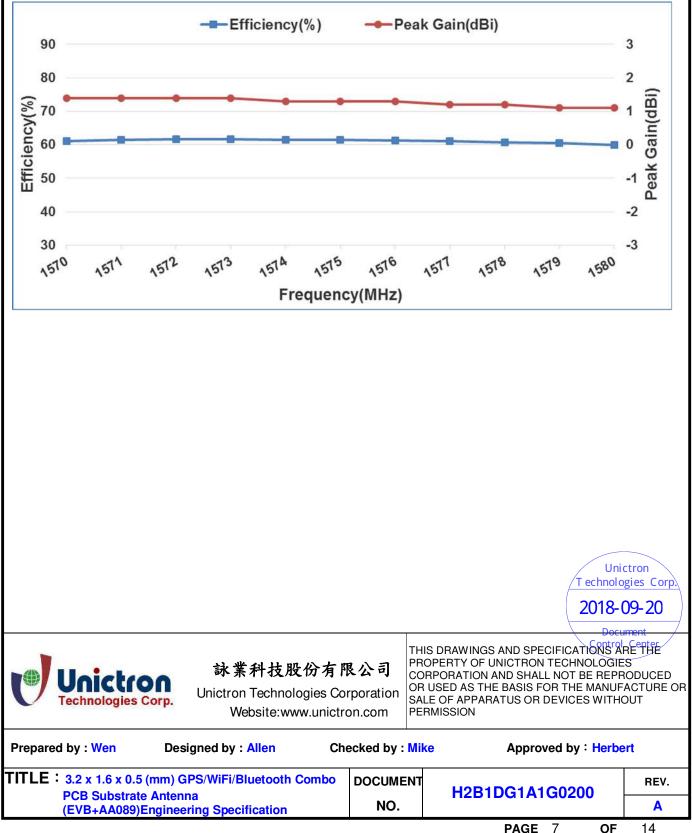




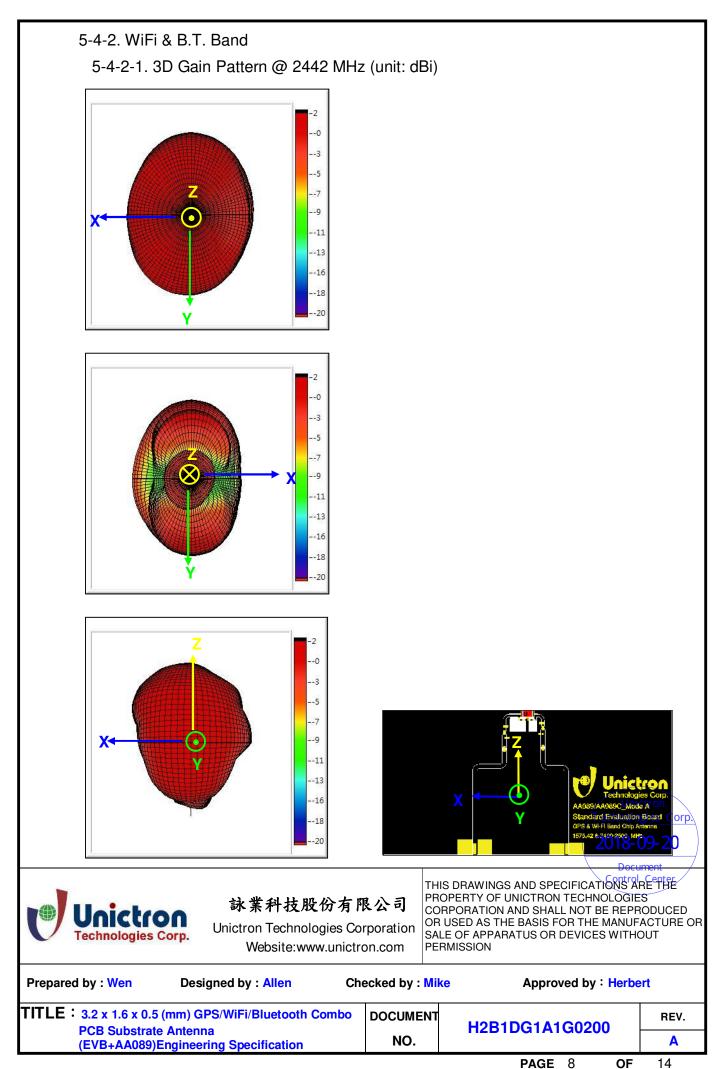
PAGE 6

5-4-1-2. 3D Efficiency Table											
Frequency(MHz)	1570	1571	1572	1573	1574	1575	1576	1577	1578	1579	1580
Efficiency(dB)	-2.1	-2.1	-2.1	-2.1	-2.1	-2.1	-2.1	-2.1	-2.2	-2.2	-2.2
Efficiency(%)	61.0	61.4	61.7	61.6	61.4	61.4	61.3	61.0	60.7	60.6	60.0
Peak Gain(dBi)	1.4	1.4	1.4	1.4	1.3	1.3	1.3	1.2	1.2	1.1	1.1



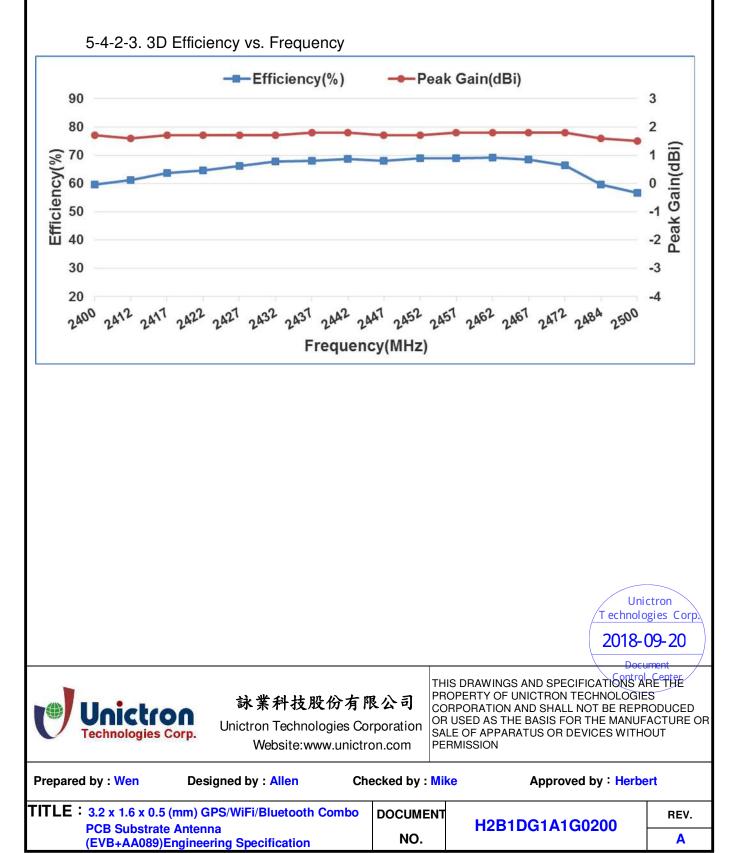


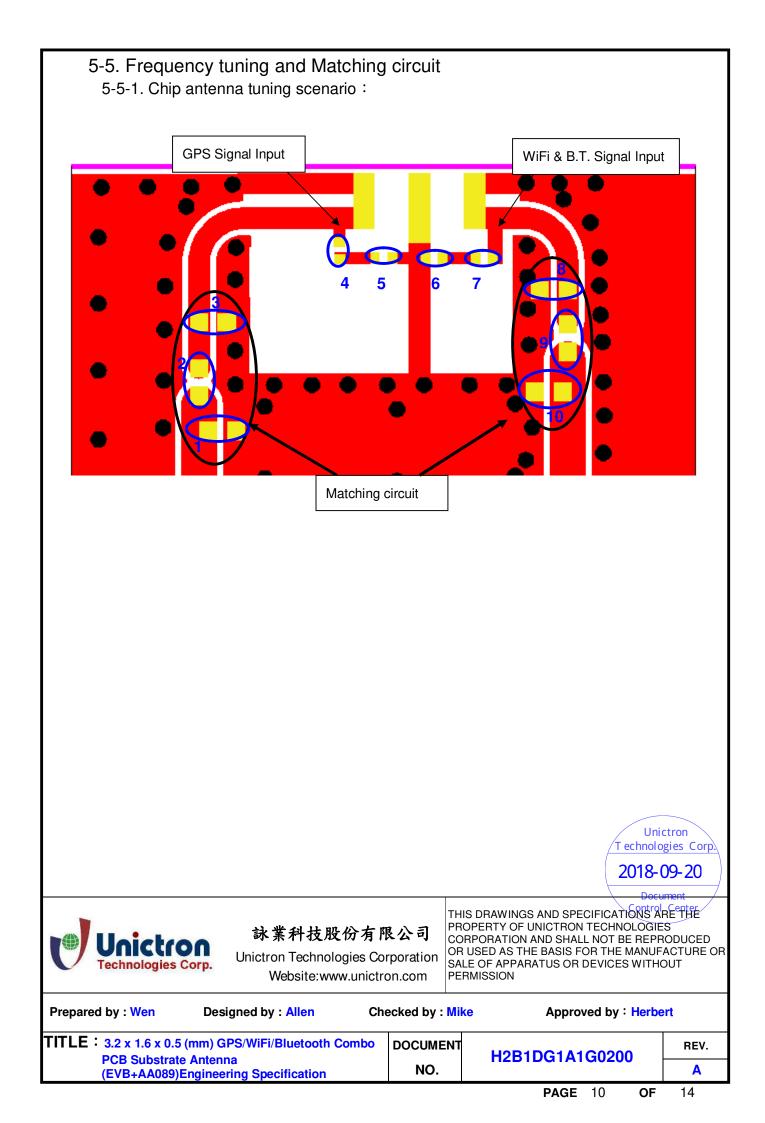
PAGE 7



14

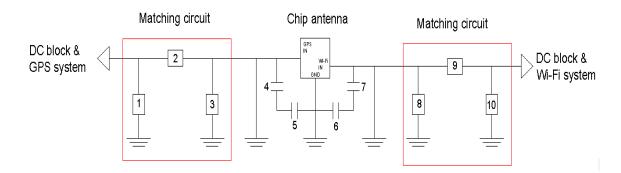
5-4-2-2. 3D Efficiency Table																
Frequency(MHz)	2400	2412	2417	2422	2427	2432	2437	2442	2447	2452	2457	2462	2467	2472	2484	2500
Efficiency(dB)	-2.2	-2.1	-2.0	-1.9	-1.8	-1.7	-1.7	-1.6	-1.7	-1.6	-1.6	-1.6	-1.6	-1.8	-2.2	-2.5
Efficiency(%)	59.6	61.1	63.8	64.7	66.1	67.7	68.1	68.7	68.1	68.9	69.0	69.2	68.5	66.4	59.7	56.6
Peak Gain(dBi)	1.7	1.6	1.7	1.7	1.7	1.7	1.8	1.8	1.7	1.7	1.8	1.8	1.8	1.8	1.6	1.5





5-5-2. Matching circuit :

With the following recommended values of matching and tuning components, the center frequencies will be about 1575.42 MHz on GPS band and 2442 MHz on WiFi (B.T.) band at our standard 80 x 40 mm² evaluation board. However, these are typical reference values which may need to be changed when circuit boards or part vendors are different.



System Matching Circuit Component									
Location	Description	Vendor	Tolerance						
1	N/A	-	-						
2	4.7nH, (0402)	MURATA	±0.3nH						
3	N/A	-	-						
4 Fine tuning element	2.7pF, (0201)	MURATA	±0.05pF						
5 Fine tuning element	1pF, (0201)	MURATA	±0.05pF						
6 Fine tuning element	0.6pF, (0201)	MURATA	±0.05pF						
7 Fine tuning element	0.8pF, (0201)	MURATA	±0.05pF						
8	N/A								
9	0 Ω, (0402)	-	-						
10	N/A								
DC Block	22pF, (0402)	MURATA	±5%						



詠業科技股份有限公司

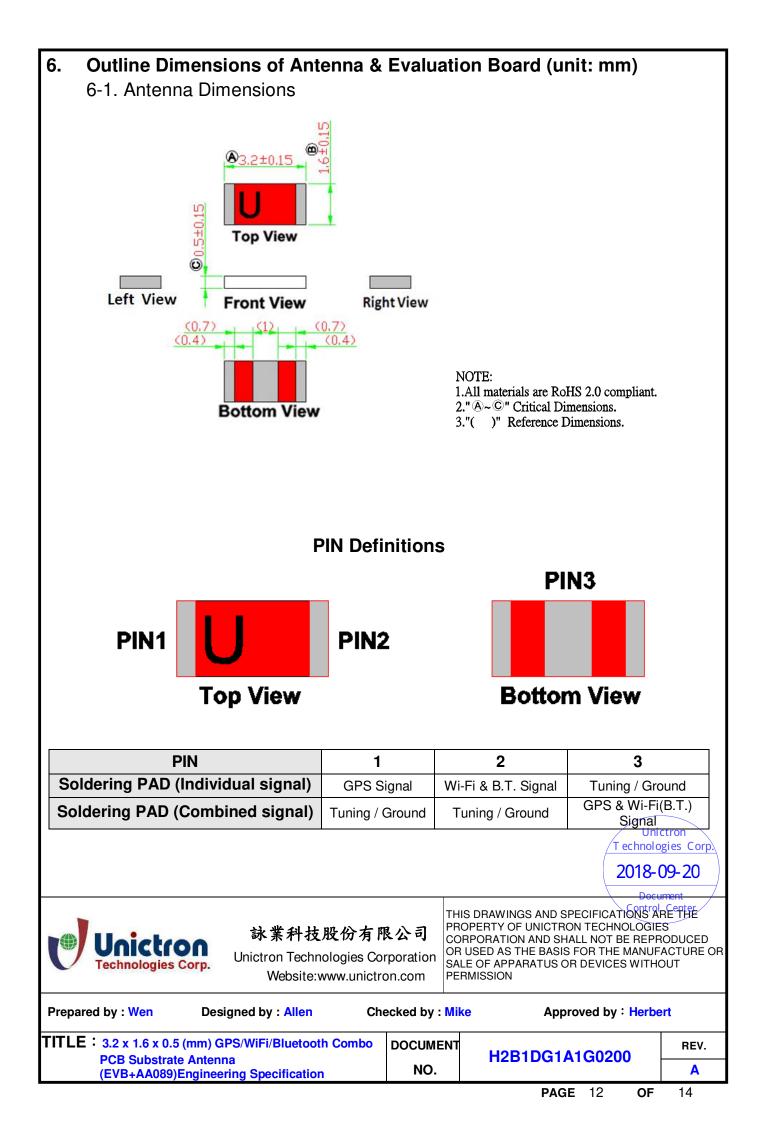
Unictron Technologies Corporation Website:www.unictron.com

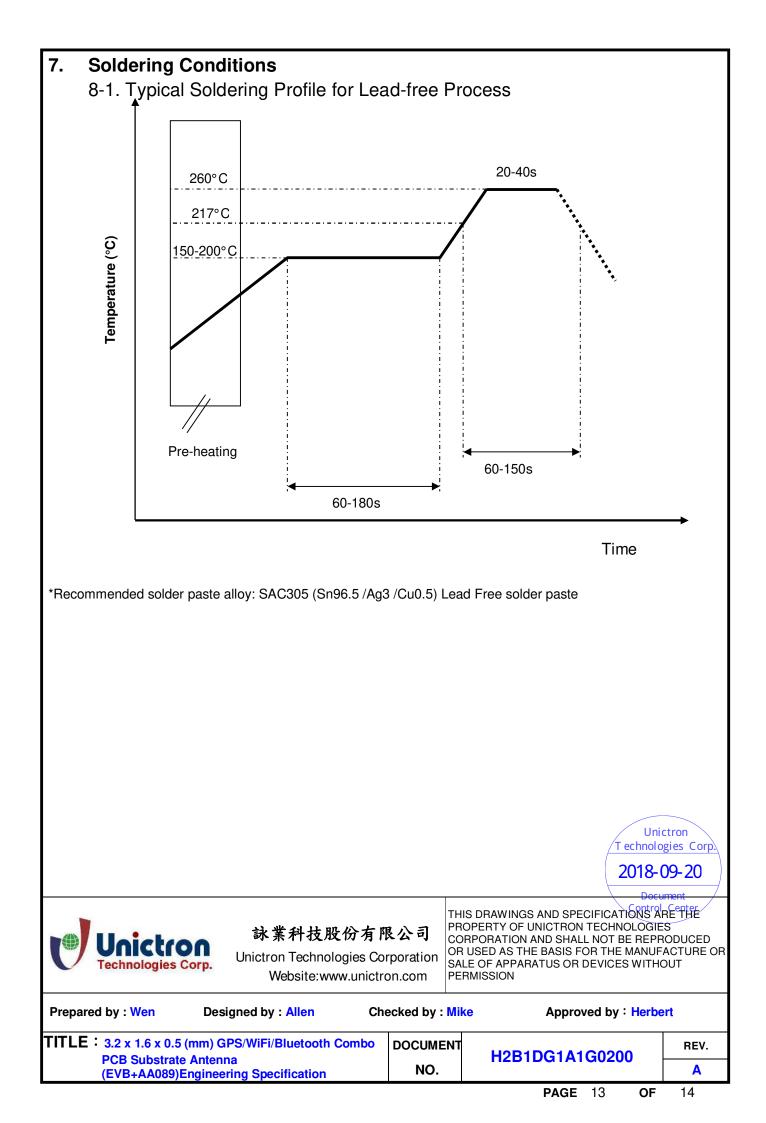
THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Unictron Technologies Corp.

2018-09-20

Prepared by : Wen	Designed by : Allen	Che	ecked by : Mil	ke	Approved by : Herbert						
TITLE: 3.2 x 1.6 x 0.5 PCB Substrate	mbo	DOCUMENT	H2B	1DG1A1	າດ	REV					
	Engineering Specification		NO.	1120	H2B1DG1A1G0200						
					PAGE	11	OF	14			





8. Reminders for users of Unictron's AA089 ceramic chip antennas

- 8-1. This chip antenna is made of ceramic materials which are relatively more rigid and brittle compared to circuit board materials. Furthermore, the length of this antenna is guite long. Bending of circuit board at the locations where chip antenna is mounted may cause the cracking of solder joints or antenna itself.
- 8-2. Punching/cutting of the break-off tab of PCB panel may cause severe bending of the circuit board which may result in cracking of solder joints or chip antenna itself. Therefore break-off tab shall be located away from the installation site of chip antenna.
- 8-3. Be cautious when ultrasonic welding process needs to be used near the locations where chip antennas are installed. Strong ultrasonic vibration may cause the cracking of chip antenna solder joints.

9. Operating & Storage Conditions

- 9-1. Operating
 - (1) Maximum Input Power: 2 W
 - (2) Operating Temperature: -40° C to 85° C
- 9-2. Storage
 - (1) Storage Temperature: -5° C to 40° C
 - (2) Relative Humidity: 20% to 70%
 - (3) Shelf Life: 1 year

10. Notice

(1) Installation Guide:

Please refer to Unictron's application note "General guidelines for the installation of Unictron's chip antennas" for further information.

(2) All specifications are subject to change without notice.



詠業科技股份有限公司 Unictron Technologies Corporation

Website:www.unictron.com

THIS DRAWINGS AND SPECIFICATIONS ARE THE PROPERTY OF UNICTRON TECHNOLOGIES CORPORATION AND SHALL NOT BE REPRODUCED OR USED AS THE BASIS FOR THE MANUFACTURE OR SALE OF APPARATUS OR DEVICES WITHOUT PERMISSION

Unictron Technologies Corp.

2018-09-20

Prepared by : Wen	Designed by : Allen	Che	ecked by : Mil	ke	Appro	ved by :	Herbe	pert				
TITLE : 3.2 x 1.6 x 0.5	DOCUMENT	H2B1	H2B1DG1A1G0200									
PCB Substrat (EVB+AA089)	e Antenna Engineering Specification		NO.	11201	HZBTDGTATG0200							
					PAGE	14	OF	14				